

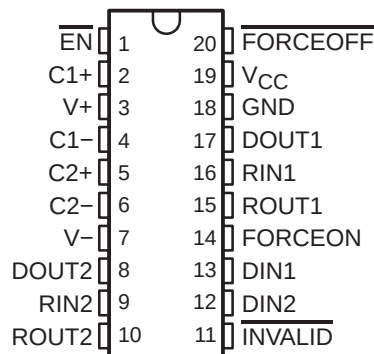
# SN65C3223, SN75C3223

## 3-V TO 5.5-V MULTICHANNEL RS-232 COMPATIBLE LINE DRIVER/RECEIVER

SLLS538B – JUNE 2002 – REVISED OCTOBER 2004

- Operate With 3-V to 5.5-V  $V_{CC}$  Supply
- Operate Up To 1 Mbit/s
- Low Standby Current . . . 1  $\mu$ A Typ
- External Capacitors . . .  $4 \times 0.1 \mu$ F
- Accept 5-V Logic Input With 3.3-V Supply
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- RS-232 Bus-Pin ESD Protection Exceeds  $\pm 15$  kV Using Human-Body Model (HBM)
- Applications
  - Battery-Powered Systems, PDAs, Notebooks, Laptops, Palmtop PCs, and Hand-Held Equipment

DB, DW, OR PW PACKAGE  
(TOP VIEW)



### description/ordering information

The SN65C3223 and SN75C3223 consist of two line drivers, two line receivers, and a dual charge-pump circuit with  $\pm 15$ -kV ESD protection pin to pin (serial-port connection pins, including GND). The devices provide the electrical interface between an asynchronous communication controller and the serial-port connector. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. The devices operate at data signaling rates up to 1 Mbit/s and a driver output slew rate of 24 V/ $\mu$ s to 150 V/ $\mu$ s.

Flexible control options for power management are available when the serial port is inactive. The auto-powerdown feature functions when FORCEON is low and FORCEOFF is high. During this mode of operation, if the device does not sense a valid RS-232 signal, the driver outputs are disabled. If FORCEOFF is set low and EN is high, both drivers and receivers are shut off, and the supply current is reduced to 1  $\mu$ A. Disconnecting the serial port or turning off the peripheral drivers causes auto-powerdown to occur. Auto-powerdown can be disabled when FORCEON and FORCEOFF are high. With auto-powerdown enabled, the device is activated automatically when a valid signal is applied to any receiver input. The INVALID output is used to notify the user if an RS-232 signal is present at any receiver input. INVALID is high (valid data) if any receiver input voltage is greater than 2.7 V or less than -2.7 V or has been between -0.3 V and 0.3 V for less than 30  $\mu$ s. INVALID is low (invalid data) if the receiver input voltage is between -0.3 V and 0.3 V for more than 30  $\mu$ s. Refer to Figure 4 for receiver input levels.

### ORDERING INFORMATION

| T <sub>A</sub> | PACKAGE†   |              | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|------------|--------------|-----------------------|------------------|
| 0°C to 70°C    | SOIC – DW  | Tube of 25   | SN75C3223DW           | 75C3223          |
|                |            | Reel of 2000 | SN75C3223DWR          |                  |
|                | SSOP – DB  | Reel of 2000 | SN75C3223DBR          | CA3223           |
|                | TSSOP – PW | Tube of 70   | SN75C3223PW           | CA3223           |
|                |            | Reel of 2000 | SN75C3223PWR          |                  |
| -40°C to 85°C  | SOIC – DW  | Tube of 25   | SN65C3223DW           | 65C3223          |
|                |            | Reel of 2000 | SN65C3223DWR          |                  |
|                | SSOP – DB  | Reel of 2000 | SN65C3223DBR          | CB3223           |
|                | TSSOP – PW | Tube of 70   | SN65C3223PW           | CB3223           |
|                |            | Reel of 2000 | SN65C3223PWR          |                  |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

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**TEXAS  
INSTRUMENTS**

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SLLS538B – JUNE 2002 – REVISED OCTOBER 2004

Function Tables

EACH DRIVER

| INPUTS |         |          |                           | OUTPUT | DRIVER STATUS                                    |
|--------|---------|----------|---------------------------|--------|--------------------------------------------------|
| DIN    | FORCEON | FORCEOFF | VALID RIN<br>RS-232 LEVEL | DOUT   |                                                  |
| X      | X       | L        | X                         | Z      | Powered off                                      |
| L      | H       | H        | X                         | H      | Normal operation with<br>auto-powerdown disabled |
| H      | H       | H        | X                         | L      |                                                  |
| L      | L       | H        | Yes                       | H      | Normal operation with<br>auto-powerdown enabled  |
| H      | L       | H        | Yes                       | L      |                                                  |
| L      | L       | H        | No                        | Z      | Powered off by<br>auto-powerdown feature         |
| H      | L       | H        | No                        | Z      |                                                  |

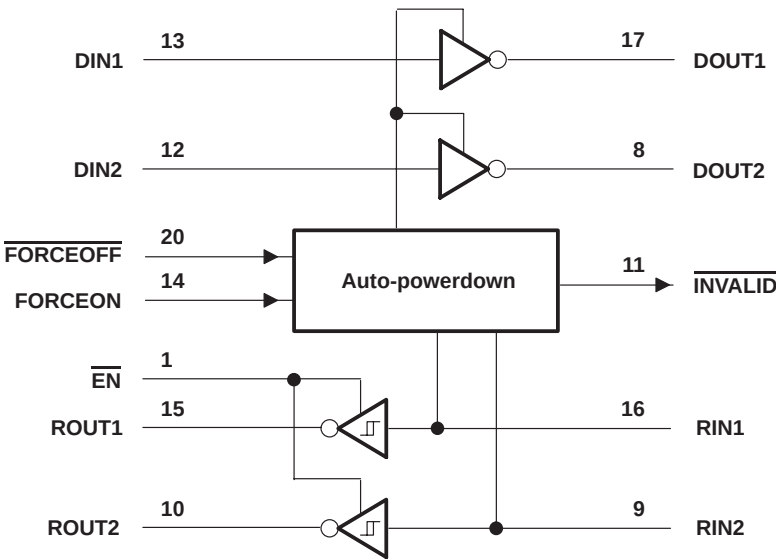
H = high level, L = low level, X = irrelevant, Z = high impedance

EACH RECEIVER

| INPUTS |    |                           | OUTPUT<br>ROUT |
|--------|----|---------------------------|----------------|
| RIN    | EN | VALID RIN<br>RS-232 LEVEL |                |
| L      | L  | X                         | H              |
| H      | L  | X                         | L              |
| X      | H  | X                         | Z              |
| Open   | L  | No                        | H              |

H = high level, L = low level, X = irrelevant,  
Z = high impedance (off), Open = input  
disconnected or connected driver off

logic diagram (positive logic)



# SN65C3223, SN75C3223

## 3-V TO 5.5-V MULTICHANNEL RS-232 COMPATIBLE LINE DRIVER/RECEIVER

SLLS538B – JUNE 2002 – REVISED OCTOBER 2004

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

|                                                                                          |                            |
|------------------------------------------------------------------------------------------|----------------------------|
| Supply voltage range, $V_{CC}$ (see Note 1)                                              | –0.3 V to 6 V              |
| Positive output supply voltage range, $V+$ (see Note 1)                                  | –0.3 V to 7 V              |
| Negative output supply voltage range, $V-$ (see Note 1)                                  | 0.3 V to –7 V              |
| Supply voltage difference, $V+ - V-$ (see Note 1)                                        | 13 V                       |
| Input voltage range, $V_I$ : Driver, $\overline{FORCEOFF}$ , $FORCEON$ , $\overline{EN}$ | –0.3 V to 6 V              |
| Receiver                                                                                 | –25 V to 25 V              |
| Output voltage range, $V_O$ : Driver                                                     | –13.2 V to 13.2 V          |
| Receiver, $INVALID$                                                                      | –0.3 V to $V_{CC} + 0.3$ V |
| Package thermal impedance, $\theta_{JA}$ (see Notes 2 and 3): DB package                 | 70°C/W                     |
| DW package                                                                               | 58°C/W                     |
| PW package                                                                               | 83°C/W                     |
| Operating virtual junction temperature, $T_J$                                            | 150°C                      |
| Storage temperature range, $T_{Stg}$                                                     | –65°C to 150°C             |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. All voltages are with respect to network GND.

2. Maximum power dissipation is a function of  $T_J(max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.

3. The package thermal impedance is calculated in accordance with JESD 51-7.

### recommended operating conditions (see Note 4 and Figure 6)

|                 |                                             |                                                           | MIN                     | NOM | MAX | UNIT |    |
|-----------------|---------------------------------------------|-----------------------------------------------------------|-------------------------|-----|-----|------|----|
| V <sub>CC</sub> | Supply voltage                              |                                                           | V <sub>CC</sub> = 3.3 V | 3   | 3.3 | 3.6  | V  |
|                 |                                             |                                                           | V <sub>CC</sub> = 5 V   | 4.5 | 5   | 5.5  |    |
| V <sub>IH</sub> | Driver and control high-level input voltage | DIN, $\overline{EN}$ , $\overline{FORCEOFF}$ ,<br>FORCEON | V <sub>CC</sub> = 3.3 V | 2   |     |      | V  |
|                 |                                             |                                                           | V <sub>CC</sub> = 5 V   | 2.4 |     |      |    |
| V <sub>IL</sub> | Driver and control low-level input voltage  | DIN, $\overline{EN}$ , $\overline{FORCEOFF}$ , FORCEON    |                         |     | 0.8 |      | V  |
| V <sub>I</sub>  | Driver and control input voltage            | DIN, $\overline{EN}$ , $\overline{FORCEOFF}$ , FORCEON    |                         |     | 0   | 5.5  | V  |
|                 | Receiver input voltage                      |                                                           |                         | −25 | 25  |      |    |
| T <sub>A</sub>  | Operating free-air temperature              |                                                           | SN65C3223               | −40 | 85  |      | °C |
|                 |                                             |                                                           | SN65C3223               | 0   | 70  |      |    |

NOTE 4: Test conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at  $V_{CC} = 5$  V  $\pm$  0.5 V.

### electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 6)

| PARAMETER       |                       | TEST CONDITIONS         | MIN                                                                                 | TYP‡  | MAX | UNIT |
|-----------------|-----------------------|-------------------------|-------------------------------------------------------------------------------------|-------|-----|------|
| I <sub>I</sub>  | Input leakage current | EN, FORCEOFF, FORCEON   |                                                                                     | ±0.01 | ±1  | μA   |
| I <sub>CC</sub> | Supply current        | Auto-powerdown disabled | No load, FORCEOFF, FORCEON at V <sub>CC</sub>                                       | 0.3   | 1   | mA   |
|                 |                       | Powered off             | No load, FORCEOFF at GND                                                            | 1     | 10  |      |
|                 |                       | Auto-powerdown enabled  | No load, FORCEOFF at V <sub>CC</sub> , FORCEON at GND, All RIN are open or grounded | 1     | 10  | μA   |

<sup>‡</sup> All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^\circ$ C.

NOTE 4: Test conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm$  0.3 V; C1 = 0.047  $\mu$ F, C2–C4 = 0.33  $\mu$ F at  $V_{CC} = 5$  V  $\pm$  0.5 V.



# SN65C3223, SN75C3223

## 3-V TO 5.5-V MULTICHANNEL RS-232 COMPATIBLE LINE DRIVER/RECEIVER

SLLS538B – JUNE 2002 – REVISED OCTOBER 2004

### DRIVER SECTION

**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 6)**

| PARAMETER                                                 | TEST CONDITIONS                                                                    | MIN | TYP <sup>†</sup> | MAX | UNIT |
|-----------------------------------------------------------|------------------------------------------------------------------------------------|-----|------------------|-----|------|
| V <sub>OH</sub> High-level output voltage                 | DOUT at R <sub>L</sub> = 3 kΩ to GND                                               | 5   | 5.4              |     | V    |
| V <sub>OL</sub> Low-level output voltage                  | DOUT at R <sub>L</sub> = 3 kΩ to GND                                               | –5  | –5.4             |     | V    |
| I <sub>IH</sub> High-level input current                  | V <sub>I</sub> = V <sub>CC</sub>                                                   |     | ±0.01            | ±1  | μA   |
| I <sub>IL</sub> Low-level input current                   | V <sub>I</sub> at GND                                                              |     | ±0.01            | ±1  | μA   |
| I <sub>OS</sub> Short-circuit output current <sup>‡</sup> | V <sub>CC</sub> = 3.6 V, V <sub>O</sub> = 0 V                                      |     | ±35              | ±60 | mA   |
|                                                           | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0 V                                      |     | ±35              | ±90 |      |
| r <sub>o</sub> Output resistance                          | V <sub>CC</sub> , V <sub>+</sub> , and V <sub>–</sub> = 0 V, V <sub>O</sub> = ±2 V | 300 | 10M              |     | Ω    |
| I <sub>off</sub> Output leakage current                   | FORCEOFF = GND, V <sub>O</sub> = ±12 V, V <sub>CC</sub> = 3 V to 3.6 V             |     |                  | ±25 | μA   |
|                                                           | V <sub>O</sub> = ±10 V, V <sub>CC</sub> = 4.5 V to 5.5 V                           |     |                  | ±25 |      |

<sup>†</sup> All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

<sup>‡</sup> Short-circuit durations should be controlled to prevent exceeding the device absolute power-dissipation ratings, and not more than one output should be shorted at a time.

NOTE 4: Test conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 μF, C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 6)**

| PARAMETER                                                | TEST CONDITIONS                                                                 | MIN                                                        | TYP <sup>†</sup> | MAX | UNIT   |
|----------------------------------------------------------|---------------------------------------------------------------------------------|------------------------------------------------------------|------------------|-----|--------|
| Maximum data rate<br>(see Figure 1)                      | R <sub>L</sub> = 3 kΩ,<br>One DOUT switching                                    | C <sub>L</sub> = 1000 pF                                   | 250              |     | kbit/s |
|                                                          |                                                                                 | C <sub>L</sub> = 250 pF, V <sub>CC</sub> = 3 V to 4.5 V    | 1000             |     |        |
|                                                          |                                                                                 | C <sub>L</sub> = 1000 pF, V <sub>CC</sub> = 4.5 V to 5.5 V | 1000             |     |        |
| t <sub>sk(p)</sub> Pulse skew <sup>§</sup>               | C <sub>L</sub> = 150 pF to 2500 pF, R <sub>L</sub> = 3 kΩ to 7 kΩ, See Figure 2 |                                                            | 300              |     | ns     |
| SR(tr) Slew rate,<br>transition region<br>(see Figure 1) | V <sub>CC</sub> = 3.3 V,<br>R <sub>L</sub> = 3 kΩ to 7 kΩ                       | C <sub>L</sub> = 150 pF to 1000 pF                         | 18               | 150 | V/μs   |

<sup>†</sup> All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

<sup>§</sup> Pulse skew is defined as |t<sub>pLH</sub> – t<sub>pHL</sub>| of each channel of the same device.

NOTE 4: Test conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 μF, C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.



# SN65C3223, SN75C3223

## 3-V TO 5.5-V MULTICHANNEL RS-232 COMPATIBLE LINE DRIVER/RECEIVER

SLLS538B – JUNE 2002 – REVISED OCTOBER 2004

### RECEIVER SECTION

**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 6)**

| PARAMETER                                                                | TEST CONDITIONS                 | MIN                   | TYP <sup>†</sup>      | MAX | UNIT |
|--------------------------------------------------------------------------|---------------------------------|-----------------------|-----------------------|-----|------|
| V <sub>OH</sub> High-level output voltage                                | I <sub>OH</sub> = -1 mA         | V <sub>CC</sub> - 0.6 | V <sub>CC</sub> - 0.1 |     | V    |
| V <sub>OL</sub> Low-level output voltage                                 | I <sub>OL</sub> = 1.6 mA        |                       |                       | 0.4 | V    |
| V <sub>IT+</sub> Positive-going input threshold voltage                  | V <sub>CC</sub> = 3.3 V         |                       | 1.6                   | 2.4 | V    |
|                                                                          | V <sub>CC</sub> = 5 V           |                       | 1.9                   | 2.4 |      |
| V <sub>IT-</sub> Negative-going input threshold voltage                  | V <sub>CC</sub> = 3.3 V         | 0.6                   | 1.1                   |     | V    |
|                                                                          | V <sub>CC</sub> = 5 V           | 0.8                   | 1.4                   |     |      |
| V <sub>hys</sub> Input hysteresis (V <sub>IT+</sub> - V <sub>IT-</sub> ) |                                 |                       | 0.5                   |     | V    |
| I <sub>off</sub> Output leakage current                                  | $\overline{\text{EN}} = V_{CC}$ |                       | ±0.05                 | ±10 | μA   |
| r <sub>i</sub> Input resistance                                          | V <sub>I</sub> = ±3 V to ±25 V  | 3                     | 5                     | 7   | kΩ   |

<sup>†</sup> All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

NOTE 4: Test conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 μF, C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4)**

| PARAMETER                                                          | TEST CONDITIONS                                                 | MIN | TYP <sup>†</sup> | MAX | UNIT |
|--------------------------------------------------------------------|-----------------------------------------------------------------|-----|------------------|-----|------|
| t <sub>PLH</sub> Propagation delay time, low- to high-level output | C <sub>L</sub> = 150 pF, See Figure 3                           |     | 150              |     | ns   |
| t <sub>PHL</sub> Propagation delay time, high- to low-level output | C <sub>L</sub> = 150 pF, See Figure 3                           |     | 150              |     | ns   |
| t <sub>en</sub> Output enable time                                 | C <sub>L</sub> = 150 pF, See Figure 4<br>R <sub>L</sub> = 3 kΩ, |     | 200              |     | ns   |
| t <sub>dis</sub> Output disable time                               | C <sub>L</sub> = 150 pF, See Figure 4<br>R <sub>L</sub> = 3 kΩ, |     | 200              |     | ns   |
| t <sub>sk(p)</sub> Pulse skew <sup>‡</sup>                         | See Figure 3                                                    |     | 50               |     | ns   |

<sup>†</sup> All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

<sup>‡</sup> Pulse skew is defined as |t<sub>PLH</sub> - t<sub>PHL</sub>| of each channel of the same device.

NOTE 4: Test conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; C1 = 0.047 μF, C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.



# SN65C3223, SN75C3223

## 3-V TO 5.5-V MULTICHANNEL RS-232 COMPATIBLE LINE DRIVER/RECEIVER

SLLS538B – JUNE 2002 – REVISED OCTOBER 2004

### AUTO-POWERDOWN SECTION

electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5)

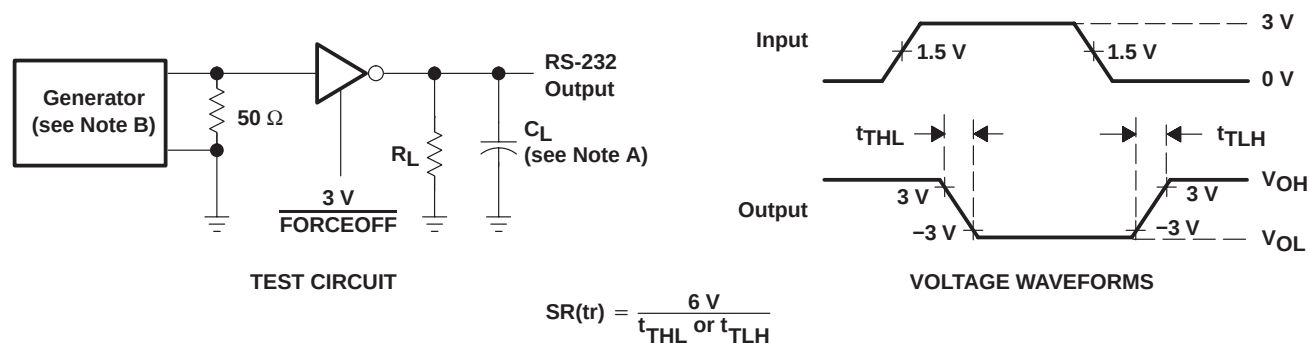
| PARAMETER               | TEST CONDITIONS                                                                                                        | MIN  | MAX            | UNIT |
|-------------------------|------------------------------------------------------------------------------------------------------------------------|------|----------------|------|
| $V_{T+}(\text{valid})$  | Receiver input threshold for INVALID high-level output voltage<br>FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$ |      | 2.7            | V    |
| $V_{T-}(\text{valid})$  | Receiver input threshold for INVALID high-level output voltage<br>FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$ | -2.7 |                | V    |
| $V_{T}(\text{invalid})$ | Receiver input threshold for INVALID low-level output voltage<br>FORCEON = GND, $\overline{\text{FORCEOFF}} = V_{CC}$  | -0.3 | 0.3            | V    |
| $V_{OH}$                | INVALID high-level output voltage<br>$I_{OH} = -1 \text{ mA}$ ,<br>$\overline{\text{FORCEOFF}} = V_{CC}$               |      | $V_{CC} - 0.6$ | V    |
| $V_{OL}$                | INVALID low-level output voltage<br>$I_{OL} = 1.6 \text{ mA}$ ,<br>$\overline{\text{FORCEOFF}} = V_{CC}$               |      | 0.4            | V    |

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5)

| PARAMETER                                                              | TYP† | UNIT          |
|------------------------------------------------------------------------|------|---------------|
| $t_{\text{valid}}$ Propagation delay time, low- to high-level output   | 1    | $\mu\text{s}$ |
| $t_{\text{invalid}}$ Propagation delay time, high- to low-level output | 30   | $\mu\text{s}$ |
| $t_{\text{en}}$ Supply enable time                                     | 100  | $\mu\text{s}$ |

† All typical values are at  $V_{CC} = 3.3 \text{ V}$  or  $V_{CC} = 5 \text{ V}$ , and  $T_A = 25^\circ\text{C}$ .

### PARAMETER MEASUREMENT INFORMATION



NOTES: A.  $C_L$  includes probe and jig capacitance.

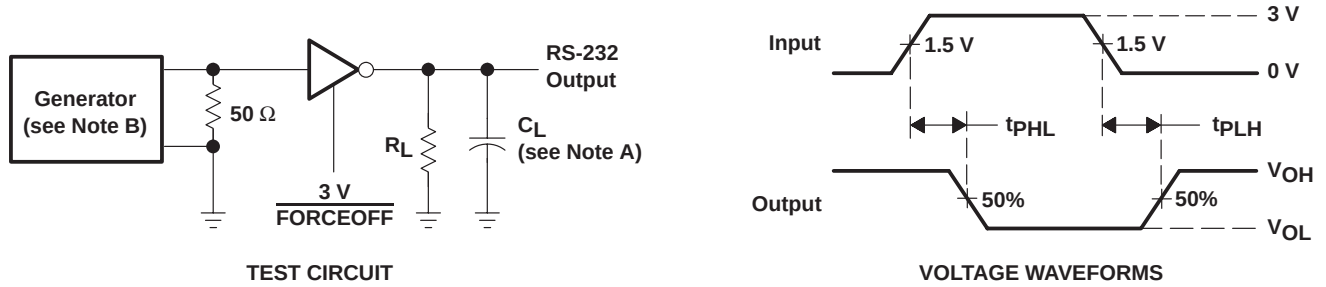
B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10 \text{ ns}$ ,  $t_f \leq 10 \text{ ns}$ .

Figure 1. Driver Slew Rate

# SN65C3223, SN75C3223 3-V TO 5.5-V MULTICHANNEL RS-232 COMPATIBLE LINE DRIVER/RECEIVER

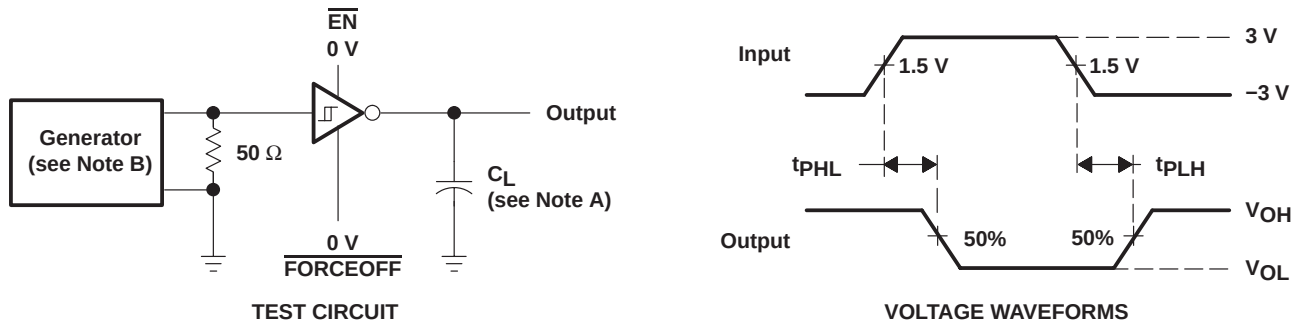
SLLS538B – JUNE 2002 – REVISED OCTOBER 2004

## PARAMETER MEASUREMENT INFORMATION



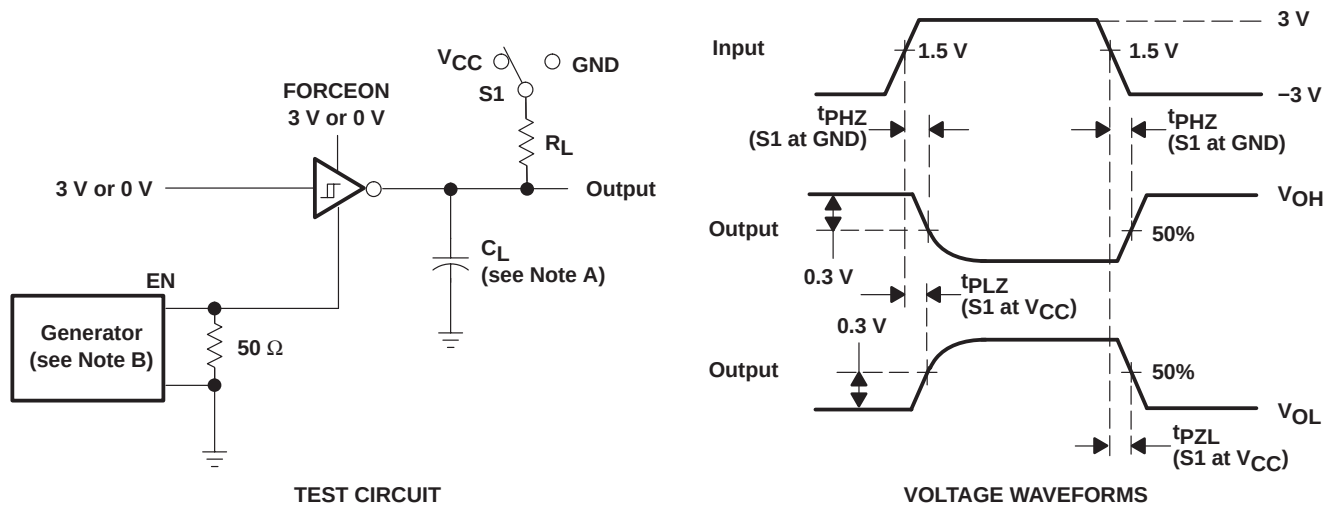
NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.

Figure 2. Driver Pulse Skew



NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. The pulse generator has the following characteristics:  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.

Figure 3. Receiver Propagation Delay Times



NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. The pulse generator has the following characteristics:  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.

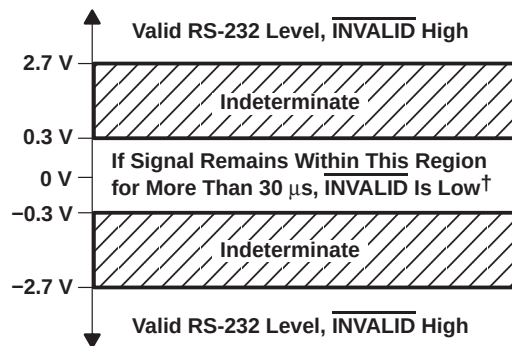
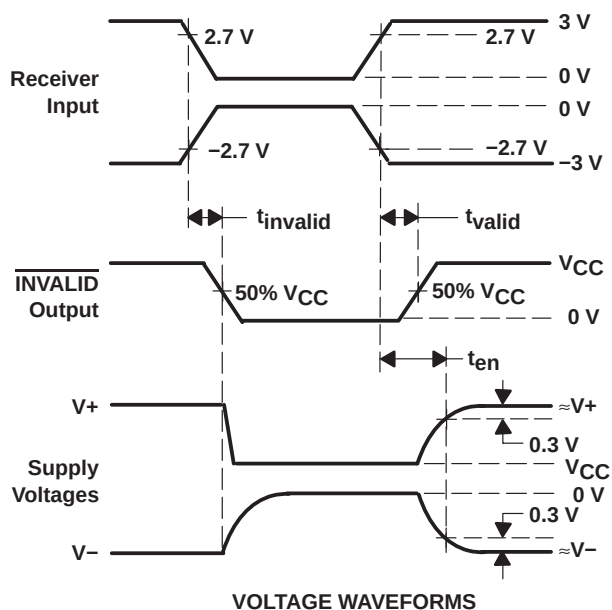
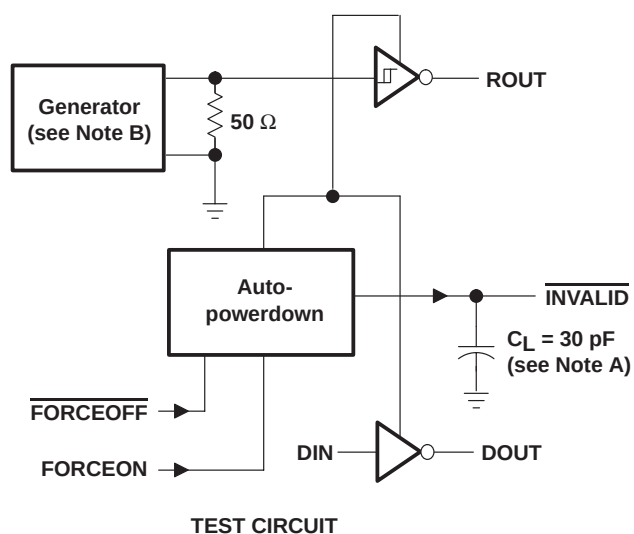
Figure 4. Receiver Enable and Disable Times

# SN65C3223, SN75C3223

## 3-V TO 5.5-V MULTICHANNEL RS-232 COMPATIBLE LINE DRIVER/RECEIVER

SLLS538B – JUNE 2002 – REVISED OCTOBER 2004

### PARAMETER MEASUREMENT INFORMATION



† Auto-powerdown disables drivers and reduces supply current to 1  $\mu\text{A}$ .

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
B. The pulse generator has the following characteristics: PRR = 5 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10 \text{ ns}$ ,  $t_f \leq 10 \text{ ns}$ .

Figure 5.  $\overline{\text{INVALID}}$  Propagation Delay Times and Supply Enabling Time

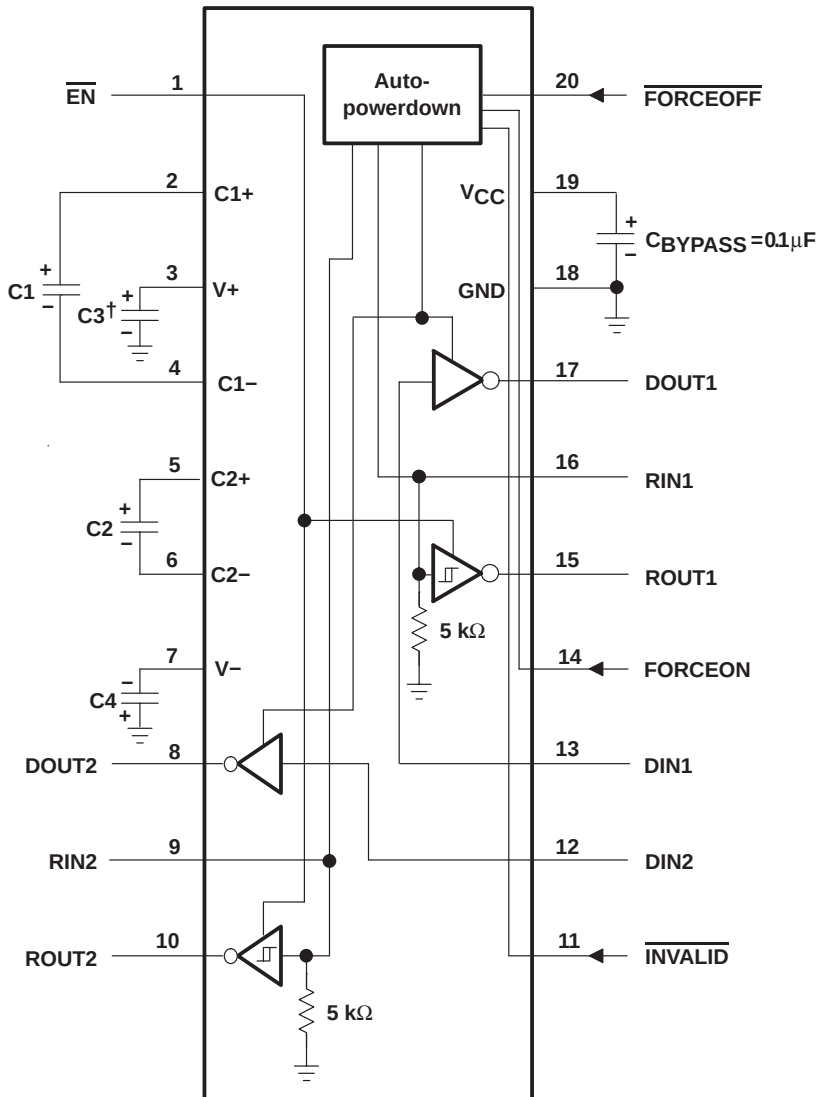


# SN65C3223, SN75C3223

## 3-V TO 5.5-V MULTICHANNEL RS-232 COMPATIBLE LINE DRIVER/RECEIVER

SLLS538B – JUNE 2002 – REVISED OCTOBER 2004

### APPLICATION INFORMATION



† C3 can be connected to V<sub>CC</sub> or GND.

NOTE A: Resistor values shown are nominal.

V<sub>CC</sub> vs CAPACITOR VALUES

| V <sub>CC</sub> | C1       | C2, C3, C4 |
|-----------------|----------|------------|
| 3.3 V ± 0.3 V   | 0.1 μF   | 0.1 μF     |
| 5 V ± 0.5 V     | 0.047 μF | 0.33 μF    |
| 3 V to 5.5 V    | 0.1 μF   | 0.47 μF    |

Figure 6. Typical Operating Circuit and Capacitor Values

## PACKAGING INFORMATION

| Orderable part number        | Status<br>(1) | Material type<br>(2) | Package   Pins  | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|------------------------------|---------------|----------------------|-----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">SN65C3223DBR</a> | Active        | Production           | SSOP (DB)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | CB3223              |
| SN65C3223DBR.A               | Active        | Production           | SSOP (DB)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | CB3223              |
| <a href="#">SN65C3223DW</a>  | Active        | Production           | SOIC (DW)   20  | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 65C3223             |
| SN65C3223DW.A                | Active        | Production           | SOIC (DW)   20  | 25   TUBE             | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | -40 to 85    | 65C3223             |
| <a href="#">SN65C3223PW</a>  | Obsolete      | Production           | TSSOP (PW)   20 | -                     | -           | Call TI                              | Call TI                           | -40 to 85    | CB3223              |
| <a href="#">SN75C3223DBR</a> | Active        | Production           | SSOP (DB)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | CA3223              |
| SN75C3223DBR.A               | Active        | Production           | SSOP (DB)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | CA3223              |
| <a href="#">SN75C3223DWR</a> | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 75C3223             |
| SN75C3223DWR.A               | Active        | Production           | SOIC (DW)   20  | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-1-260C-UNLIM                | 0 to 70      | 75C3223             |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

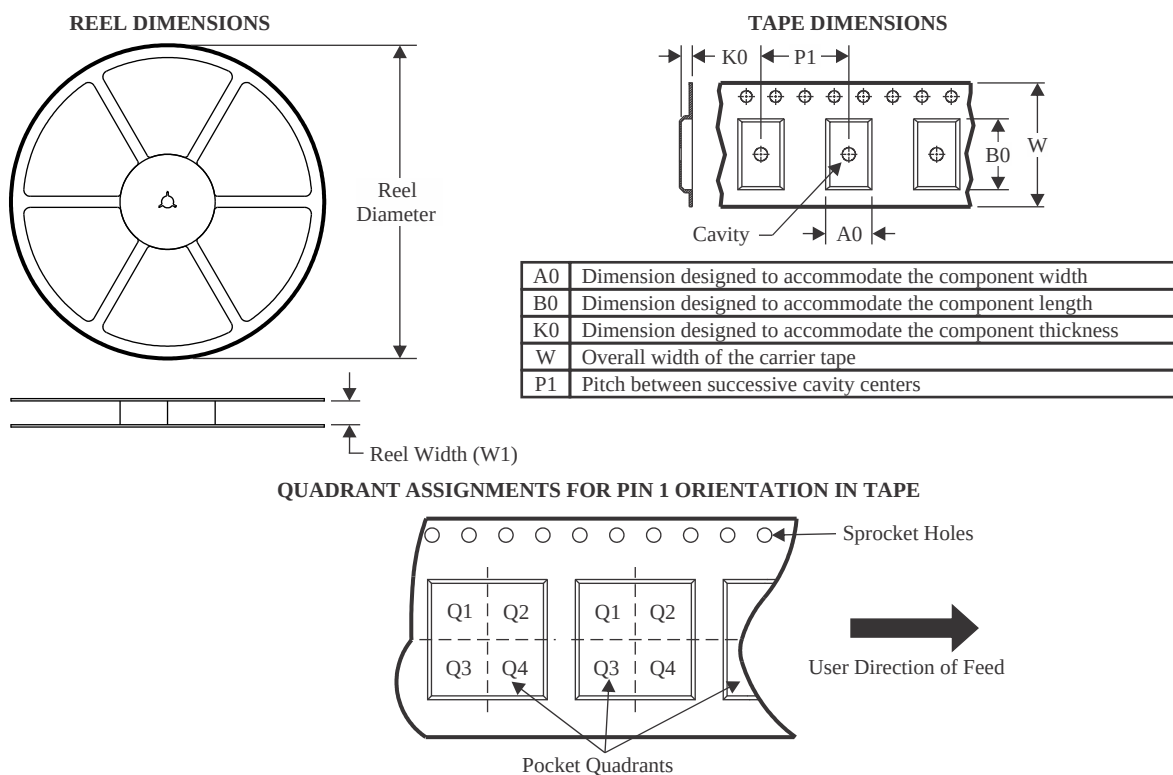
Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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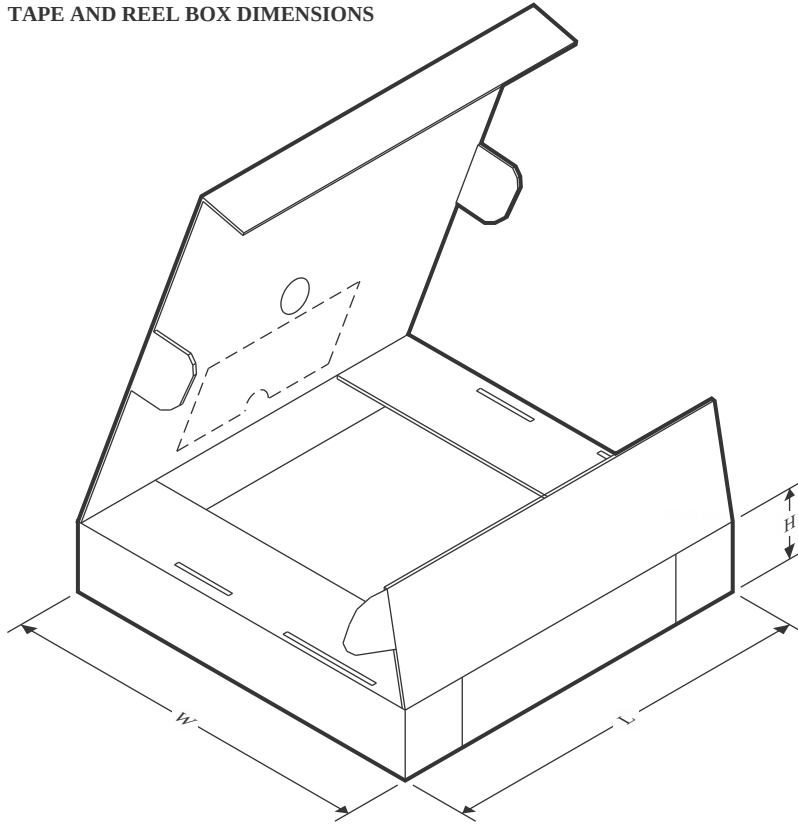
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN65C3223DBR | SSOP         | DB              | 20   | 2000 | 330.0              | 16.4               | 8.2     | 7.5     | 2.5     | 12.0    | 16.0   | Q1            |
| SN75C3223DBR | SSOP         | DB              | 20   | 2000 | 330.0              | 16.4               | 8.2     | 7.5     | 2.5     | 12.0    | 16.0   | Q1            |
| SN75C3223DWR | SOIC         | DW              | 20   | 2000 | 330.0              | 24.4               | 10.8    | 13.3    | 2.7     | 12.0    | 24.0   | Q1            |

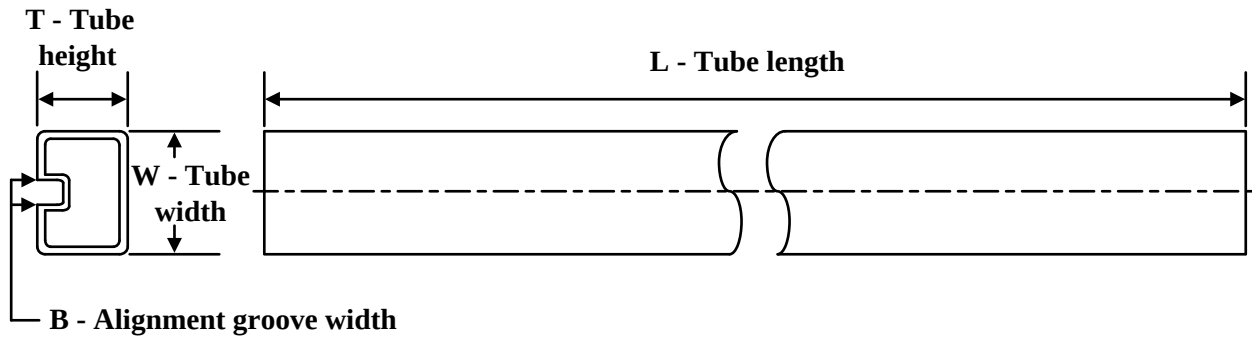
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

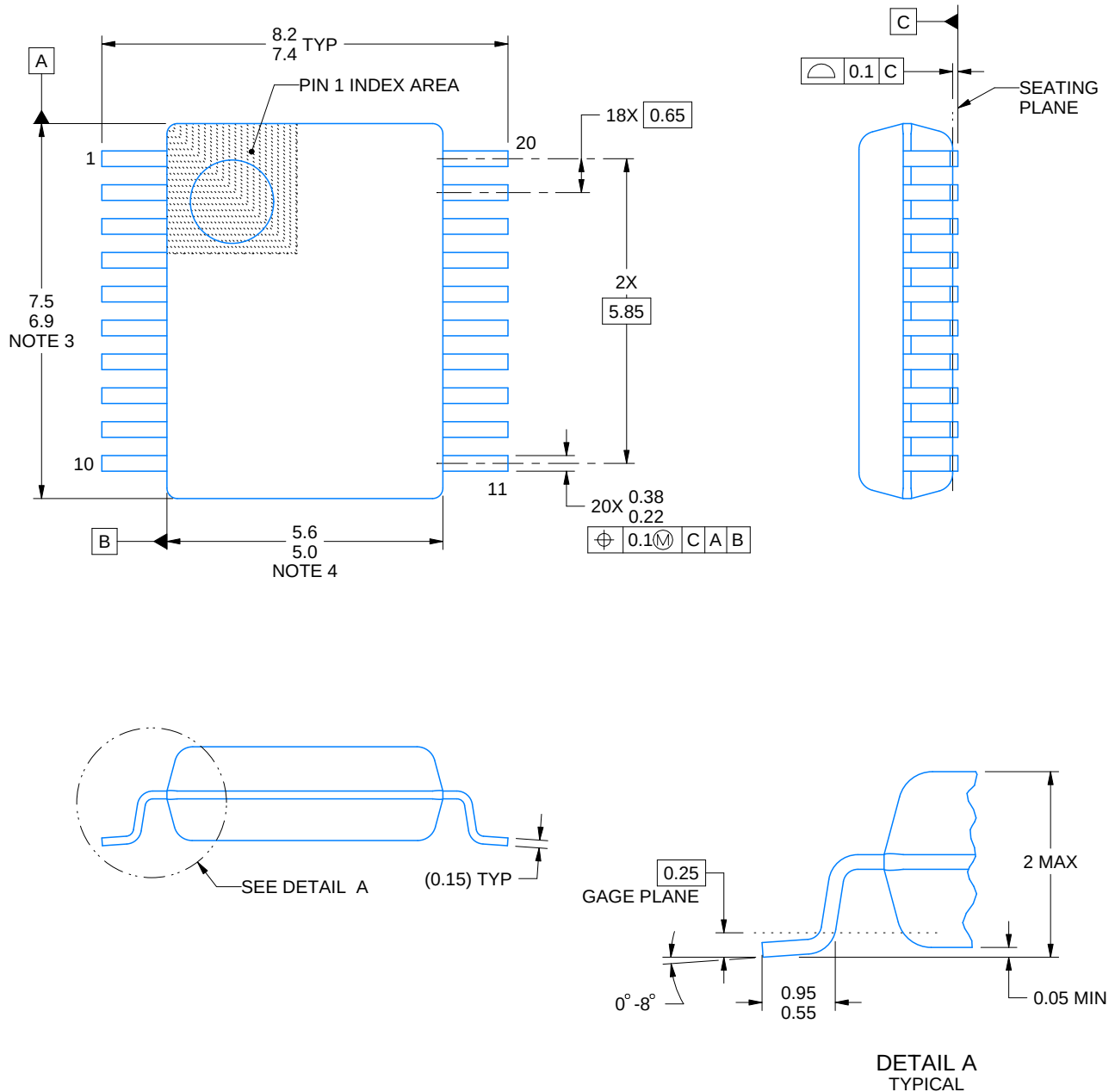
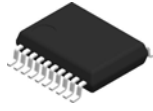
| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN65C3223DBR | SSOP         | DB              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| SN75C3223DBR | SSOP         | DB              | 20   | 2000 | 353.0       | 353.0      | 32.0        |
| SN75C3223DWR | SOIC         | DW              | 20   | 2000 | 356.0       | 356.0      | 45.0        |

## TUBE



\*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN65C3223DW   | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |
| SN65C3223DW.A | DW           | SOIC         | 20   | 25  | 507    | 12.83  | 5080   | 6.6    |



4214851/B 08/2019

## NOTES:

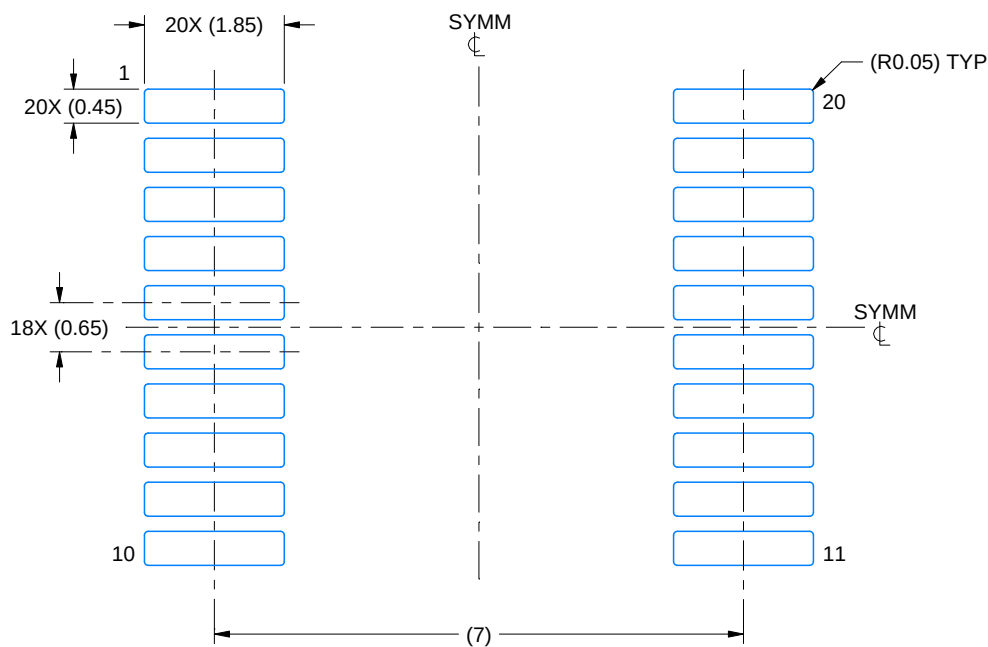
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-150.

# EXAMPLE BOARD LAYOUT

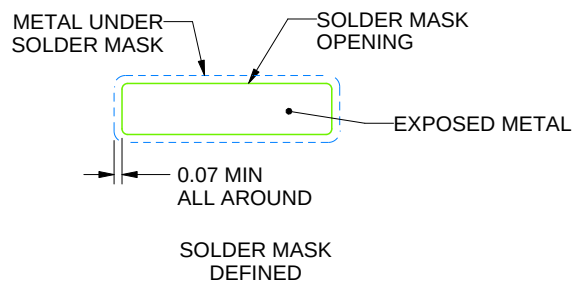
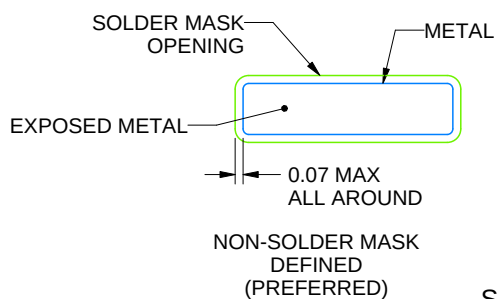
DB0020A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4214851/B 08/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

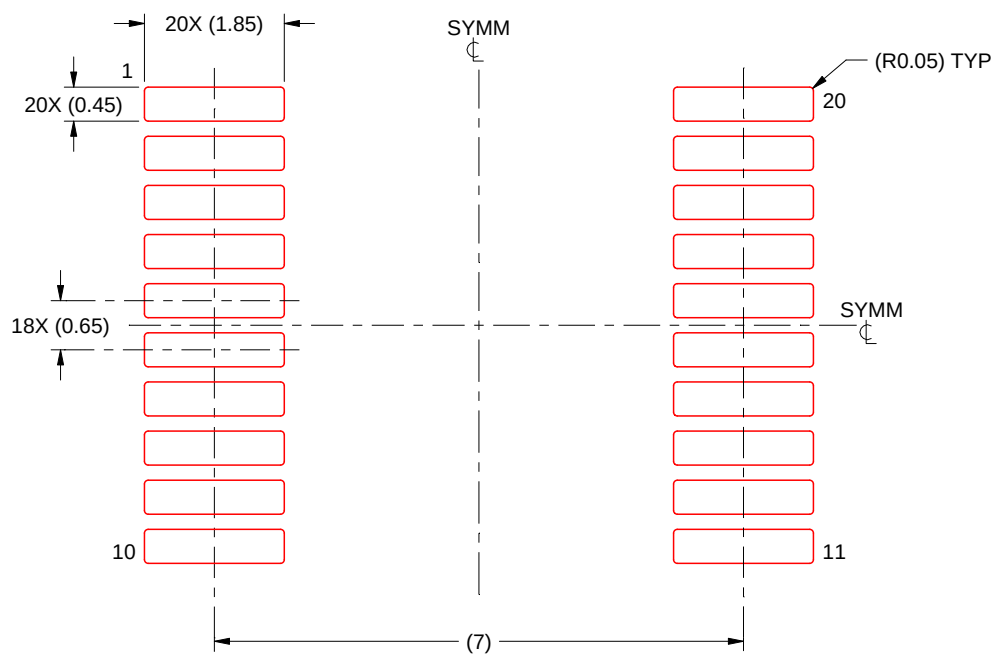


## EXAMPLE STENCIL DESIGN

DB0020A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE

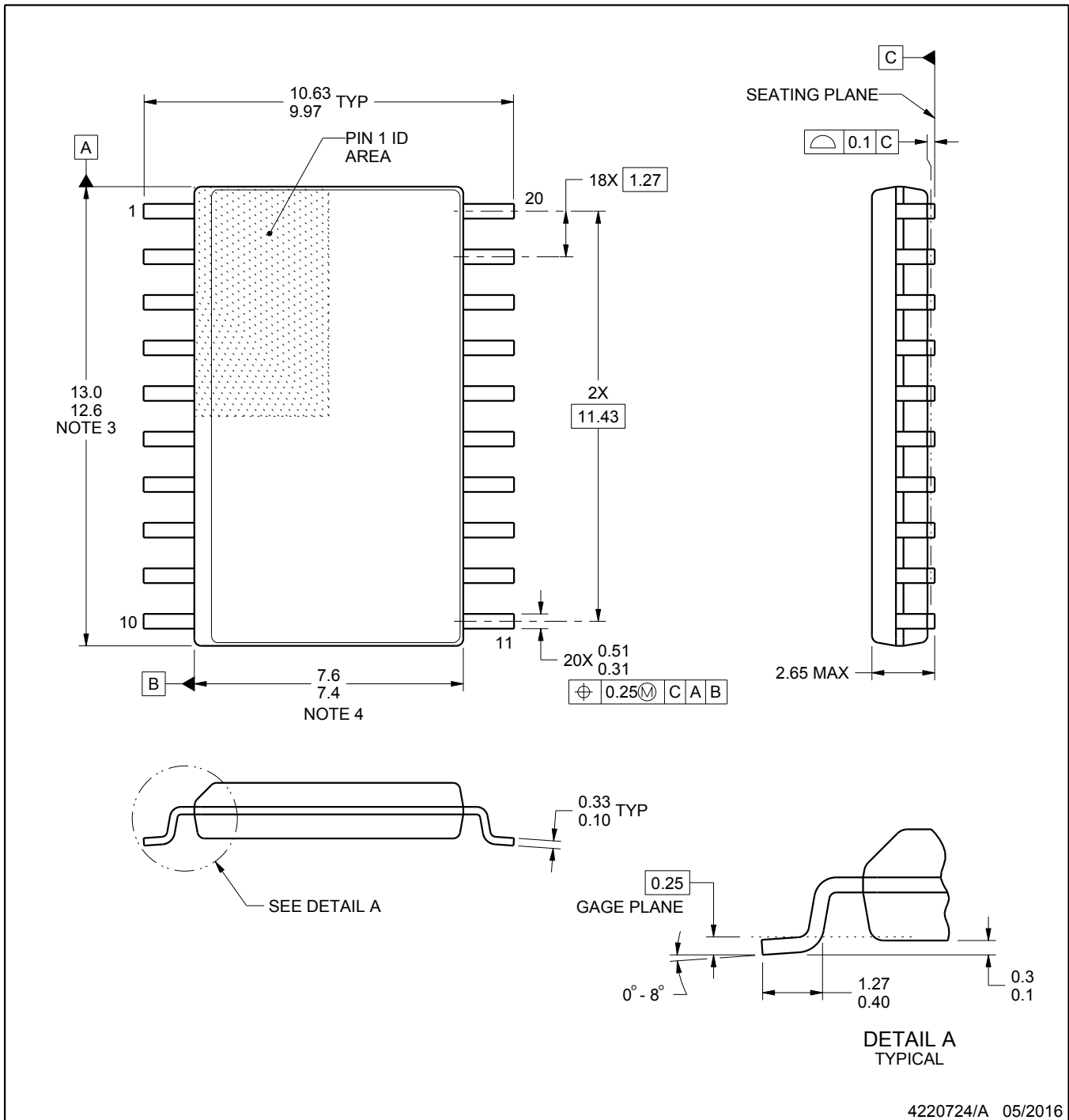


SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4214851/B 08/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



4220724/A 05/2016

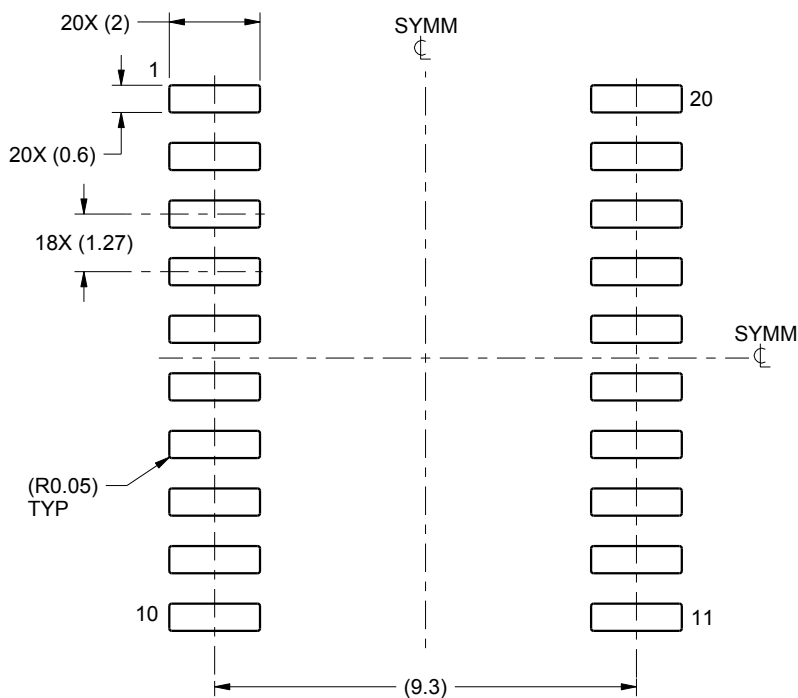
## NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

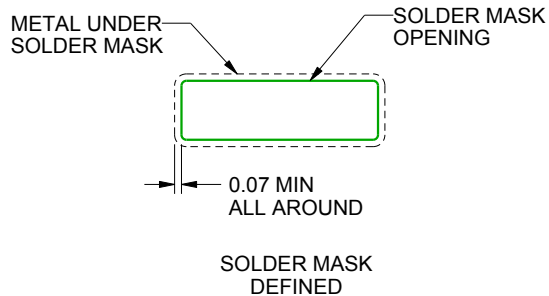
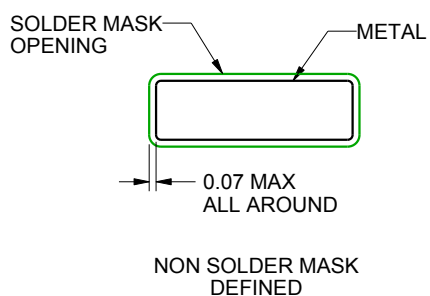
**DW0020A**

### SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:6X



## SOLDER MASK DETAILS

4220724/A 05/2016

NOTES: (continued)

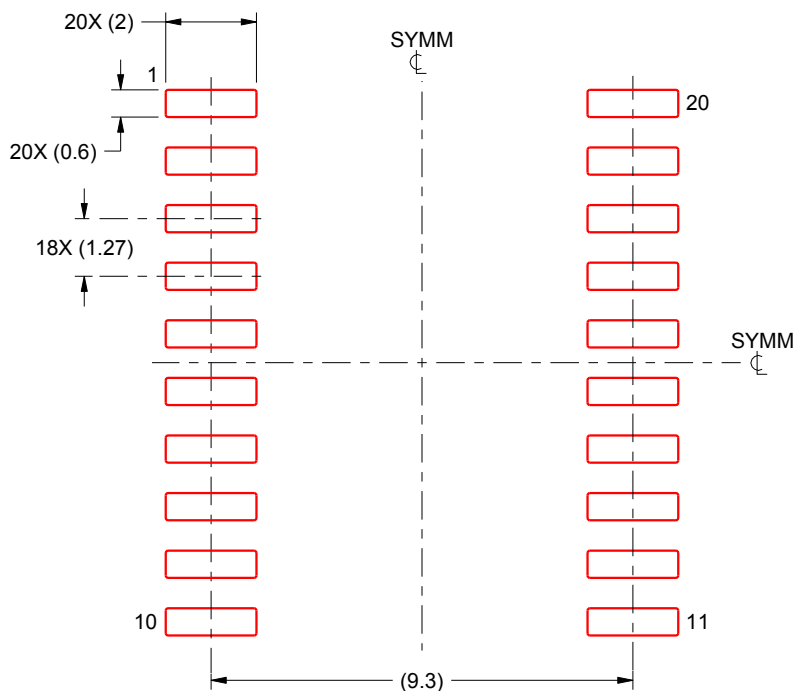
6. Publication IPC-7351 may have alternate designs.  
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DW0020A

SOIC - 2.65 mm max height

SOIC

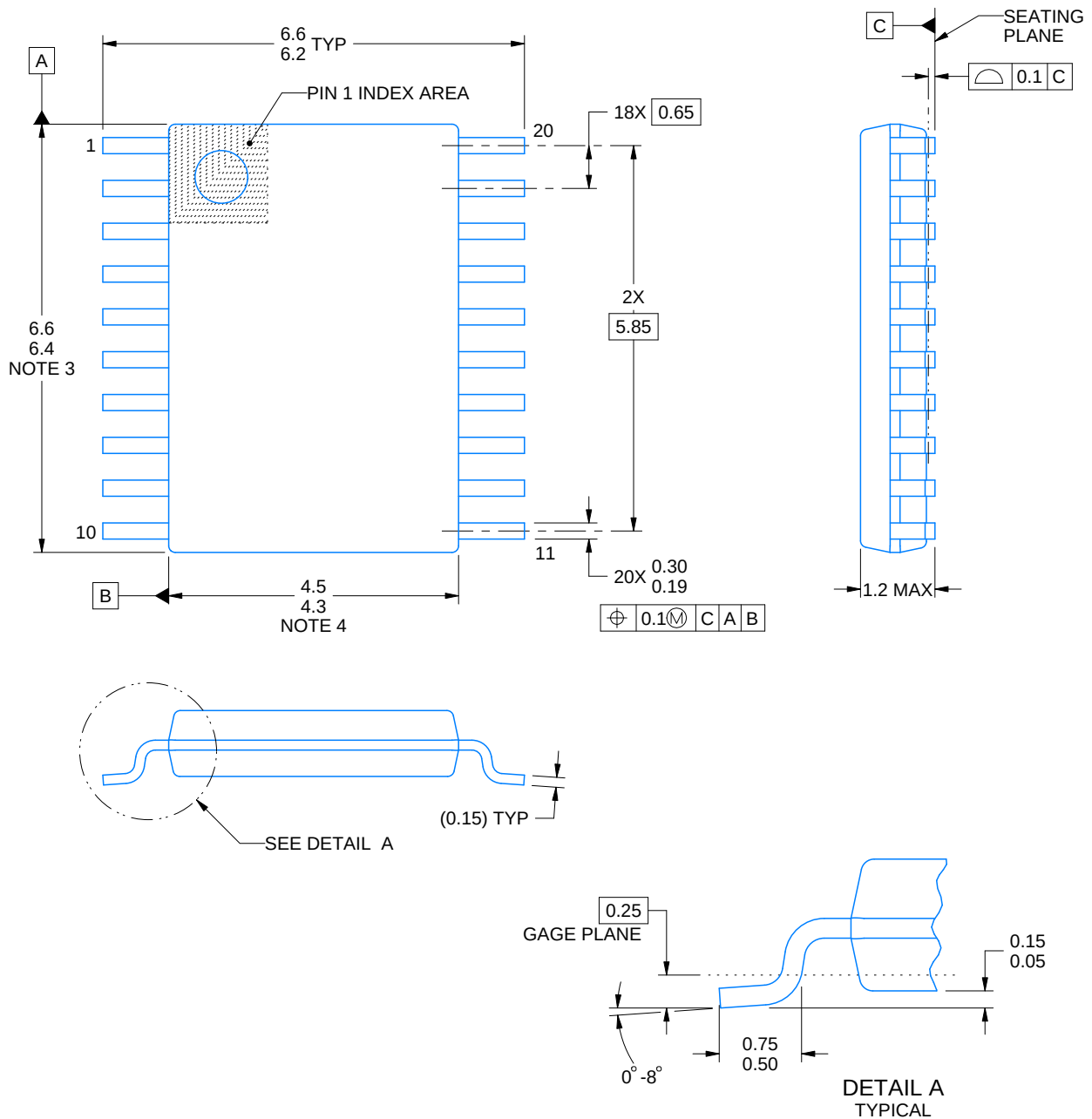
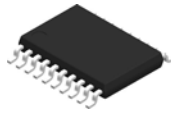


SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:6X

4220724/A 05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



4220206/A 02/2017

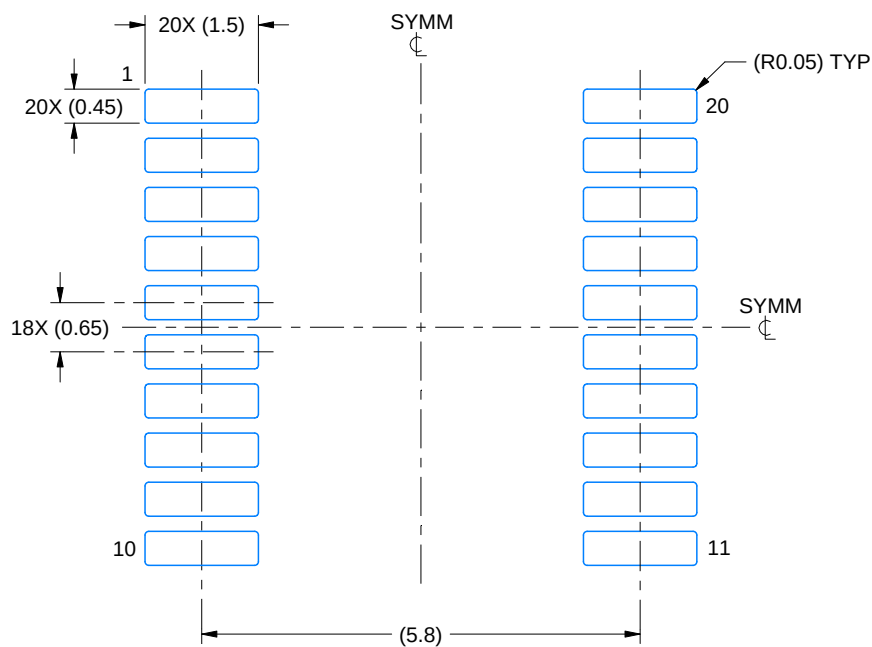
## NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

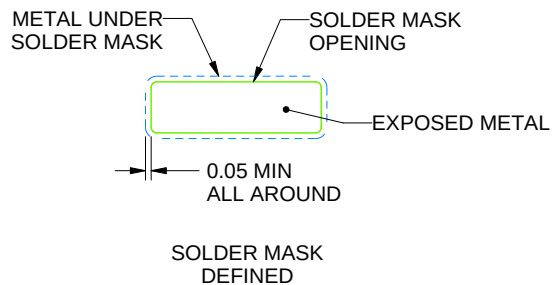
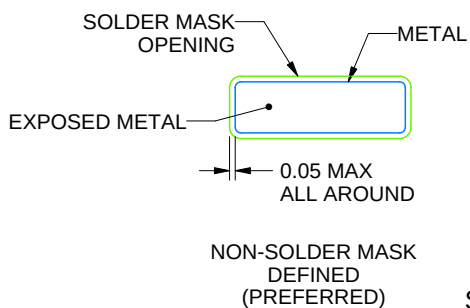
**PW0020A**

**TSSOP - 1.2 mm max height**

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



## SOLDER MASK DETAILS

4220206/A 02/2017

NOTES: (continued)

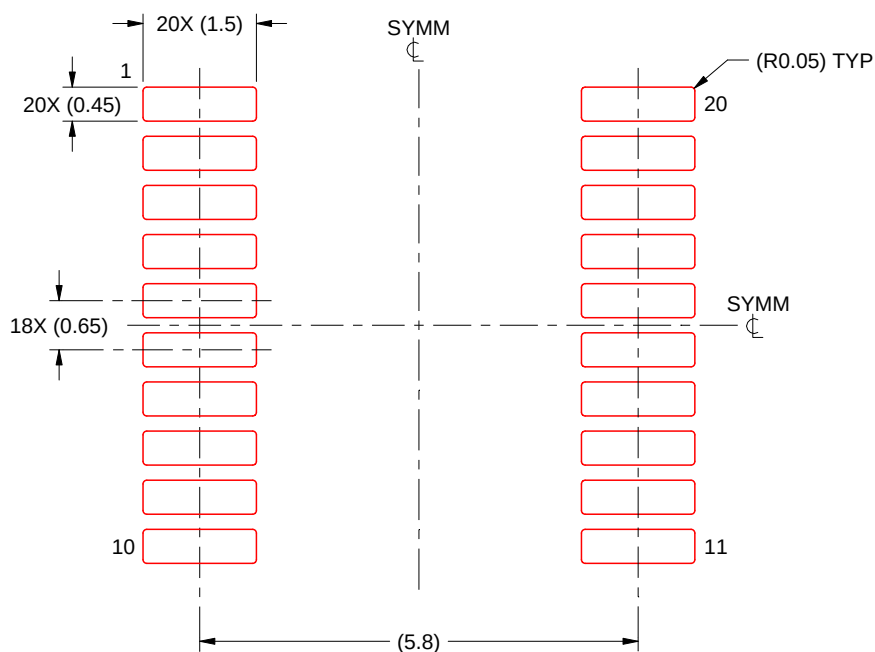
6. Publication IPC-7351 may have alternate designs.  
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

PW0020A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220206/A 02/2017

NOTES: (continued)

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9. Board assembly site may have different recommendations for stencil design.

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